Silicon Schottky Barrier Detector Diodes

CDB, DDB Series

Features

- Low 1/f Noise
- Bonded Junctions for Reliability
- Planar Passivated Beam–Lead and Chip Construction

Description

Alpha packaged, beam–lead and chip Schottky barrier detector diodes are designed for applications through 40 GHz in Ka–band. They are made by the deposition of a suitable barrier metal on an epitaxial silicon substrate to form the junction. The process and choice of materials result in low series resistance along with a narrow spread of capacitance values for close impedance control. P–type silicon is used to obtain superior 1/f noise characteristics.

The packaged diodes are suitable for use in waveguide, coaxial, and stripline applications.

Applications

These diodes are categorized by TSS (Tangential Signal Sensitivity) for detector applications in four frequency ranges: S, X, Ku, and Ka–band. However, they can also be used as modulators, high speed switches and low power limiters. RF parameters on chips and beam–lead diodes are tested on a sample basis, while breakdown voltage and capacitance measurements are 100% tested. Packaged diodes are 100% RF tested.



The beam-lead and chip diodes can also be mounted in a variety of packages or on special customer substrates.

Unmounted beam-lead diodes are especially well suited for use in MIC applications. Mounted beam-lead diodes can be easily used in MIC, stripline or other such circuitry.

A complete line of chips is shown for those MIC applications where the chip and wire approach is more desirable.

TSS, is the one parameter that best describes a diode's use as a video detector. It is defined as the amount of signal power, below a one milliwatt reference level, required to produce an output pulse whose amplitude is sufficient to raise the noise fluctuations by an amount equal to the average noise level. TSS is approximately 4 dB above the Minimum Detectable Signal.

The Schottky barrier diodes in this data sheet are of P-type construction and are optimized for low noise, particularly in the 1/f region. They require a small forward bias (to overcome the barrier potential) if efficient operation is required, especially at power levels below -20 dBm. Bias not only increases sensitivity but also greatly reduces parameter variation due to temperature change. Video impedance is a direct function of bias and closely follows the 28/I (mA) relationship. This is important

to pulse fidelity, since the video impedance in conjunction with the detector output capacitance affects the effective amplifier bandwidth.

Bias does, however, increase noise, particularly in the 1/f region. Therefore, it should be kept at as low a level as possible (typically 5–50 microamps).

Voltage output versus power input as a function of load resistance and bias is shown in Figures 1a and 1b.

Electrical Specifications

		Ele	Electrical Characteristics				Test Conditions	
Frequency	Part	TSS dBm ^{1,2}		-IF Ims)	C _J @ 0V (pF)	Frequency	lielden	Outline Drawing
Band	Number	min	min	max	max	GHz	Holder	Holder Number
CX	DDB4517006	50	500	700	-	5, 11	P-066	207001
CX	DDL6672-006	48	500	700	-	5, 11	P-085	075–001 ⁴
C–X	DDB4517-000	47	500	700	_	5, 11	P-066	207-001
C–X	DDL6672-000	45	500	700	-	5, 11	P-085	075–001 ⁴
x	DDL6725000	48	500	700	_	10.525	Optimized	005801
к	DDB6673094	50	-	-	0.10	24.15	Optimized	207001
КА	DDB6673-000	40	500	700		34.86	P064	207-001

Packaged Low 1/f Noise (6.0 dB Max)

Beam-Lead Low 1/f Noise (6.0 dB Max)

X	DDB4719-000	50	500	700	0.15	10	_	130-011
×	DDB2503-000	50	500	700	0.15	10	-	491006
x	DDB3321-000	50	500	700	0.15	10	-	295011
x	DDB3268000	50	500	700	0.15	10	-	364-011
Ku	DDB3263000	48	500	700	0.10	16	-	130011
Ku	DDB2504000	48	500	700	0.10	16	-	491006
Ku	DDB3266000	49	500	700	0.10	16	_	295011
Ku	DDB4393000	49	500	700	0.10	16	-	364-011
ĸ	DDB5098000	50 ³	800 ³	1200 ³	0.10	24.15	-	130011
ĸ	DDB2265-000	50 ³	800 ³	1200 ³	0.10	24.15	-	491-006
ĸ	DDB3267-000	50 ³	800 ³	1200 ³	0.10	24.15	-	295011
ĸ	DDB3269-000	50 ³	800 ³	1200 ³	0.10	24.15	-	364-011

Chip Low 1/f Noise (6.0 dB Max)

X/Ku	CDB7620-000	50	500	700	0.15	18	-	526-006
Ku/K	CDB7619-000	48	500	700	0.10	20		526-006

1. Bias = 50 μA.

2. Video Bandwidth = 10 MHz.

3. Bias = 30 μA.

4. For stripline applications, all diodes in the 075-001 package are available with flattened leads.

Maximum operating temperature =150°C.

CDB, **DDB** Series



Typical Performance Data





a) Unbiased

DC Return

Input



RF Bypass

RF Bypass

Video Output

Video Output

Load Resistor

Load Resistor

Bias Supply









Frequency Table

Band	Frequencies (GHz)				
UHF	Up to 1				
L	1 – 2				
S	2 - 4				
С	4 – 8				
x	8.2 - 12.4				
Ku	12.4 – 18				
к	18.0 - 26.5				
Ka	26.5 - 40				
mm	40 – 100				